

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	10/597994	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:20
L2	2	("6248646").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/17 17:21
L3	2	("5349207").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/17 17:21
L4	2	("5441911").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/17 17:21
L5	1	"4661199".PN.	USPAT; USOCR	OR	ON	2009/01/17 17:22
L6	1	"5652436".PN.	USPAT; USOCR	OR	ON	2009/01/17 17:22
L7	1	6 and (wafer or substrate or silicon or oxide or nitride or front or rear or side or cavity or recess or surface or coincides or CMP or bonding or material or adhsive or photolithographic or glue or ultra or violet)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:25

L8	2	2 and (wafer or substrate or silicon or oxide or nitride or front or rear or side or cavity or recess or surface or coincides or CMP or bonding or material or adhsvie or photolithographic or glue or ultra or violet)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:37
L9	2	(standard adj substrate) and (small adj substrate) and cavity and (bonding adj material) and surface	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:40
L10	3	(standard adj substrate) and (small adj substrate) and cavity	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:41
L11	2	("4963114").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/17 17:42
L12	2	11 and (wafer or substrate or silicon or oxide or nitride or front or rear or side or cavity or recess or surface or coincides or CMP or bonding or material or adhsvie or photolithographic or glue or ultra or violet)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:42
L13	2	("5272104").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/17 17:43

L14	2	13 and (wafer or substrate or silicon or oxide or nitride or front or rear or side or cavity or recess or surface or coincides or CMP or bonding or material or adhsvie or photolithographic or glue or ultra or violet)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:43
L15	1002	438/309	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:45
L16	143	438/603	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:45
L17	460	438/604	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:45
L18	5911	438/692	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:46
L19	5768	438/637	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:46
L20	2216	438/723	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:46

L21	841	438/743	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:46
L22	953	438/756	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:46
L23	396	438/931	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:46
L24	427	438/739	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/01/17 17:46

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